

Tensorized Optical Neural Network Architecture

Tech ID: 33812 / UC Case 2023-531-0

ABSTRACT

Researchers at the University of California, Davis have developed a large-scale, energyefficient, high-throughput, and compact tensorized optical neural network (TONN) exploiting the tensor-train decomposition architecture on an integrated III–V-on-silicon metal–oxide– semiconductor capacitor (MOSCAP) platform.

FULL DESCRIPTION

The technology provides a solution of using a TONN architecture to address and mitigate challenges of optical neural networks. The TONN architecture is scalable to 1024×1024 synapses and beyond, which is extremely difficult for conventional integrated ONN architectures, by using cascaded multi-wavelength small-radix (e.g., 8×8) tensor cores.

APPLICATIONS

- Computer vision
- Speech recognition
- Machine translations
- Medical diagnoses
- Advanced gaming
- Large-volume and cost-effective EPIC manufacturing

FEATURES/BENEFITS

Scalable synapses

▶ Utilizes fewer Mach–Zehnder interferometers (MZIs) and fewer cascaded stages of MZIs than conventional ONNs

- Maintains a training accuracy for Modified National Institute of Standards and Technology handwritten digit classification tasks
- ▶ Reduces the footprint-energy compared with digital electronics ANN hardware
- Steps ahead compared with silicon photonic and phase-change material technologies
- Overcomes the limited scalability of conventional ONNs
- Reduces the dependency on the type of task, unlike CNNs
- ▶ Does away with the need for alignment of III–V diode laser chips to Silicon Photonics chips, thereby eliminating related losses and packaging complexity

PATENT STATUS

Patent Pending

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INVENTORS

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OTHER INFORMATION

KEYWORDS neural networks, optical computing, photonic neural networks, tensor

core decomposition

CATEGORIZED AS

Optics and

Photonics

- All Optics and
- Photonics
- Communications
 - Optical
- Computer
 - Hardware
- Imaging
 - Medical
- Semiconductors
 - Design and
 Fabrication

Sensors &

Instrumentation

Scientific/Research

RELATED CASES

2023-531-0

ADDITIONAL TECHNOLOGIES BY THESE INVENTORS

- ▶ Higher-Speed and More Energy-Efficient Signal Processing Platform for Neural Networks
- Crystal Orientation Optimized Optical Frequency Shifter
- Hyperspectral Compressive Imaging
- Multi-Wavelength, Nanophotonic, Neural Computing System
- Athermal Nanophotonic Lasers
- Ultra-High Resolution Multi-Platform Heterodyne Optical Imaging
- Multi-Wavelength, Laser Array
- Optical Interposers for Embedded Photonics Integration
- Ultrahigh-Bandwidth Low-Latency Reconfigurable Memory Interconnects by Wavelength Routing
- Development of a CMOS-Compatible, Nano-photonic, Laser
- ▶ Energy Efficient and Scalable Reconfigurable All-to-All Switching Architecture
- Compressive High-Speed Optical Transceiver
- All-Optical Regenerators
- Silicon Based Chirped Grating Emitter for Uniform Power Emission
- Energy-Efficient All-Optical Nanophotonic Computing
- ▶ 3D Photonic and Electronic Neuromorphic Artificial Intelligence
- Adapting Existing Computer Networks to a Quantum-Based Internet Future

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